

Single N-channel MOSFET

ELM4N6014FRA-S

<http://www.elm-tech.com>

■ General description

ELM4N6014FRA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate threshold voltage.

■ Features

- $V_{ds}=60V$
- $I_d=5A$
- $R_{ds(on)} = 50m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} = 60m\Omega$ ($V_{gs}=4.5V$)

■ Maximum absolute ratings

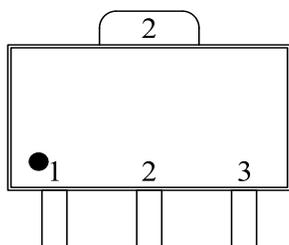
| Parameter | Symbol | Limit | Unit | Note | |
|--|-----------|------------------|------------|------|---|
| Drain-source voltage | V_{ds} | 60 | V | | |
| Gate-source voltage | V_{gs} | ± 20 | V | | |
| Continuous drain current ($V_{gs}=10V$) | I_d | $T_a=25^\circ C$ | 5.0 | A | 1 |
| | | $T_a=70^\circ C$ | 3.5 | | |
| Pulsed drain current | I_{dm} | 20 | A | 2 | |
| Single pulse avalanche energy | EAS | 22 | mJ | 3 | |
| Avalanche current | I_{as} | 21 | A | | |
| Power dissipation | P_d | 2 | W | 4 | |
| Storage temperature range | T_{stg} | -55 to 150 | $^\circ C$ | | |
| Operating junction temperature range | T_j | -55 to 150 | $^\circ C$ | | |

■ Thermal characteristics

| Parameter | Symbol | Typ. | Max. | Unit | Note |
|--|-----------------|------|------|--------------|------|
| Thermal resistance junction-to-ambient | $R_{\theta ja}$ | - | 62.5 | $^\circ C/W$ | 1 |

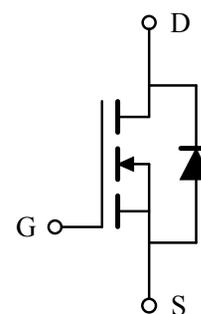
■ Pin configuration

SOT-89(TOP VIEW)



| Pin No. | Pin name |
|---------|----------|
| 1 | GATE |
| 2 | DRAIN |
| 3 | SOURCE |

■ Circuit



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■Electrical characteristics

T_j=25°C. Unless otherwise noted.

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit | Note |
|------------------------------------|---------------------|--|------|------|------|------|------|
| STATIC PARAMETERS | | | | | | | |
| Drain-source breakdown voltage | BV _{dss} | I _d =250μA, V _{gs} =0V | 60 | - | - | V | |
| Static drain-source on-resistance | R _{ds(on)} | V _{gs} =10V, I _d =4A | - | 40 | 50 | mΩ | 2 |
| | | V _{gs} =4.5V, I _d =3A | - | 45 | 60 | | |
| Gate threshold voltage | V _{gs(th)} | V _{gs} =V _{ds} , I _d =250μA | 1.0 | - | 2.5 | V | |
| Drain-source leakage current | I _{dss} | V _{ds} =48V, V _{gs} =0V | - | - | 1 | μA | |
| | | V _{ds} =48V, V _{gs} =0V, T _j =55°C | - | - | 5 | | |
| Gate-body leakage current | I _{gss} | V _{gs} =±20V, V _{ds} =0V | - | - | ±100 | nA | |
| Forward transconductance | G _{fs} | V _{ds} =5V, I _d =4A | - | 28.3 | - | S | |
| Diode forward voltage | V _{sd} | V _{gs} =0V, I _s =1A | - | - | 1.2 | V | 2 |
| Max. body-diode continuous current | I _s | V _{gs} =V _{ds} =0V, Force current | - | - | 5 | A | 1, 5 |
| DYNAMIC PARAMETERS | | | | | | | |
| Input capacitance | C _{iss} | V _{ds} =15V, V _{gs} =0V, f=1MHz | - | 1027 | - | pF | |
| Output capacitance | C _{oss} | | - | 65 | - | pF | |
| Reverse transfer capacitance | C _{rss} | | - | 46 | - | pF | |
| SWITCHING PARAMETERS | | | | | | | |
| Total gate charge (10V) | Q _g | V _{ds} =48V, V _{gs} =10V, I _d =4A | - | 19.0 | - | nC | |
| Gate-source charge | Q _{gs} | | - | 2.6 | - | nC | |
| Gate-drain charge | Q _{gd} | | - | 4.1 | - | nC | |
| Turn-on delay time | t _{d(on)} | V _{ds} =30V, V _{gs} =10V R _{gen} =3.3Ω, I _d =4A | - | 3 | - | ns | |
| Turn-on rise time | t _r | | - | 34 | - | ns | |
| Turn-off delay time | t _{d(off)} | | - | 23 | - | ns | |
| Turn-off fall time | t _f | | - | 6 | - | ns | |
| Reverse recovery time | t _{rr} | I _f =4A, di/dt=100A/μs | - | 12.1 | - | ns | |
| Reverse recovery charge | Q _{rr} | | - | 6.7 | - | nC | |

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. The EAS data shows Max. rating . The test condition is V_{dd}=25V, V_{gs}=10V, L=0.1mH, I_{as}=21A.
4. The power dissipation is limited by 150°C junction temperature.
5. The data is theoretically the same as I_d and I_{dm}, in real applications, should be limited by total power dissipation.

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■ Typical characteristics

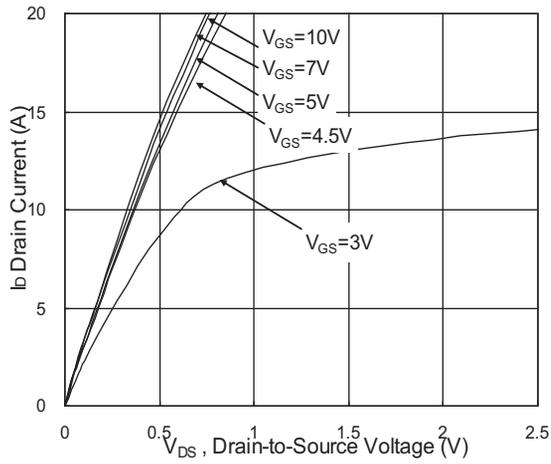


Fig.1 Typical Output Characteristics

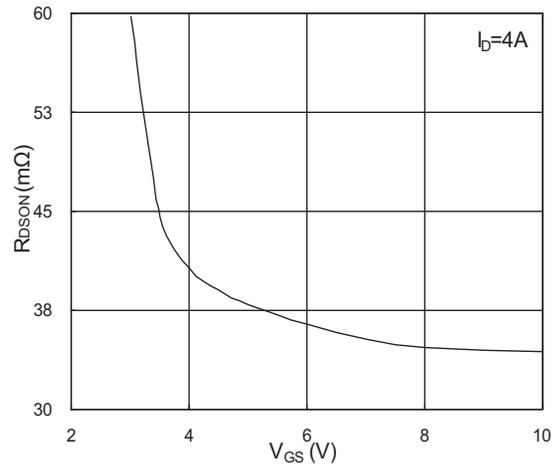


Fig.2 On-Resistance vs G-S Voltage

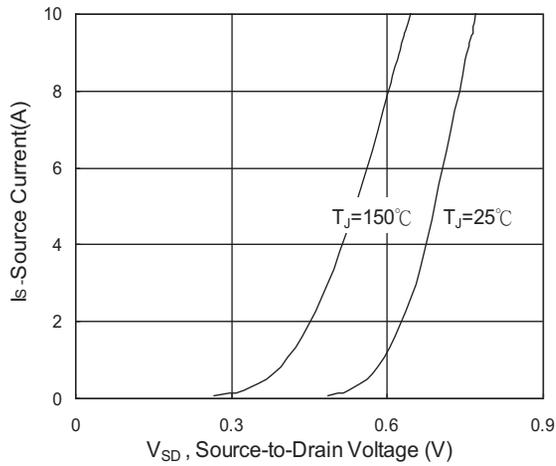


Fig.3 Source Drain Forward Characteristics

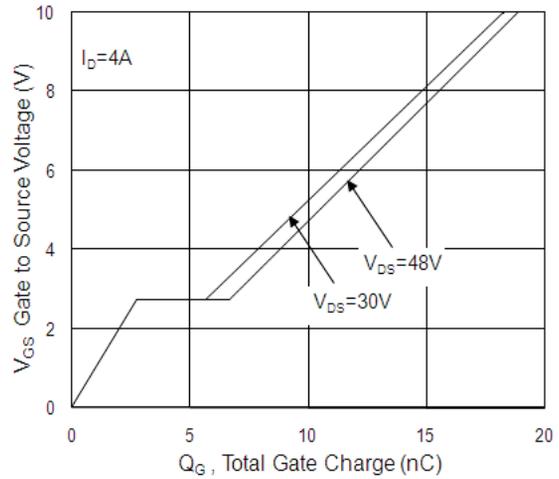


Fig.4 Gate-Charge Characteristics

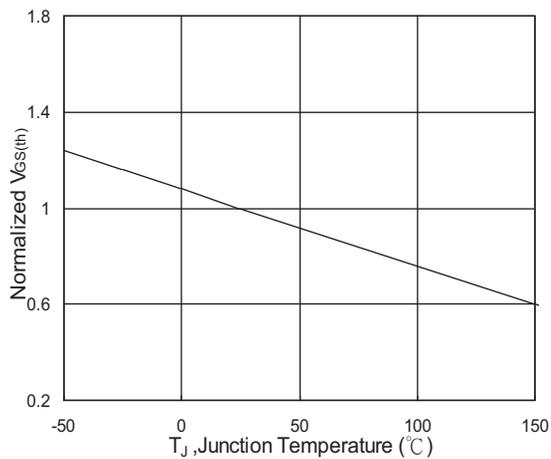


Fig.5 Normalized $V_{GS(th)}$ vs T_J

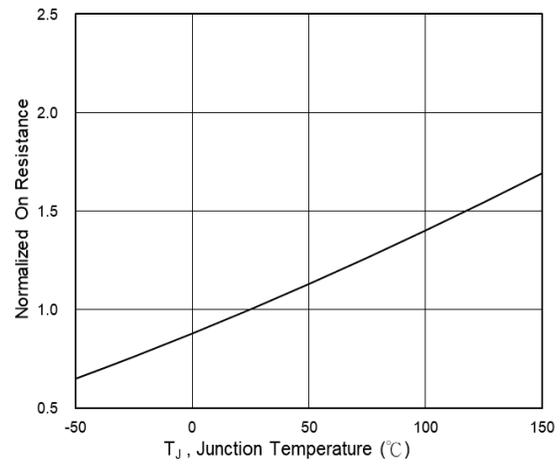


Fig.6 Normalized $R_{DS(on)}$ vs T_J

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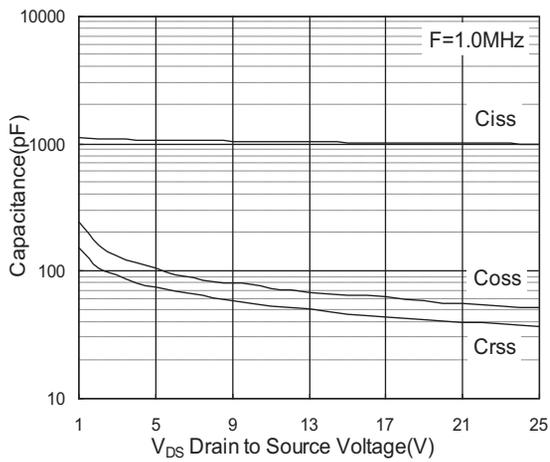


Fig.7 Capacitance

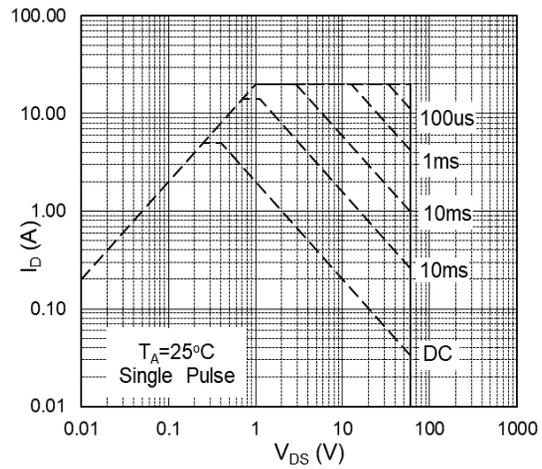


Fig.8 Safe Operating Area

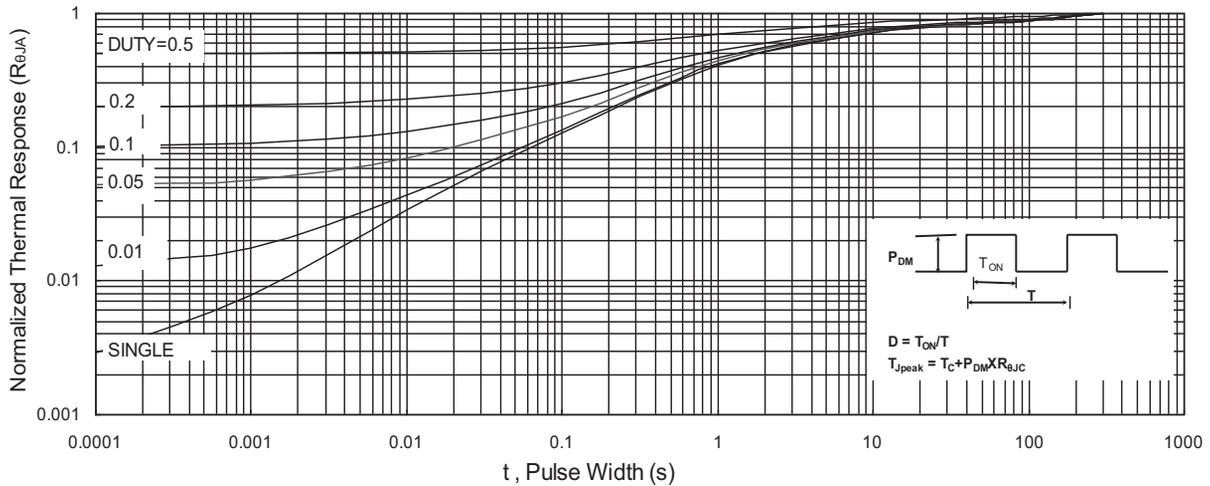


Fig.9 Normalized Maximum Transient Thermal Impedance

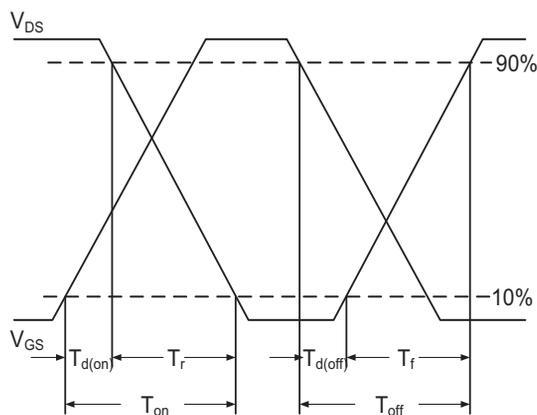


Fig.10 Switching Time Waveform

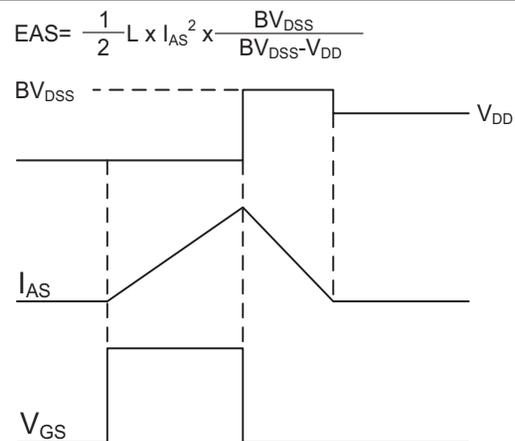


Fig.11 Unclamped Inductive Switching Waveform